TEXAS INSTRUMENTS
Data sheet acquired from Harris Semiconductor
SCHS067A – Revised March 2002

CD4502B Types

CMOS Strobed Hex Inverter/Buffer

High-Voltage Types (20-Volt Rating)

■ CD4502B consists of six inverter/buffers with 3-state outputs. A logic "1" on the OUTPUT DISABLE input produces a high-impedance state in all six outputs. This feature permits common busing of the outputs, thus simplifying system design. A Logic "1" on the INHIBIT input switches all six outputs to logic "0" if the OUTPUT DISABLE input is a logic "0". This device is capable of driving two standard TTL loads, which is equivalent to six times the JEDEC "B"-series I_{OL} standard.

The CD4502B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic package (E suffix), 16-lead small-outline package (NSR suffix), and in chip form (H suffix). This device is similar to the MC14502.

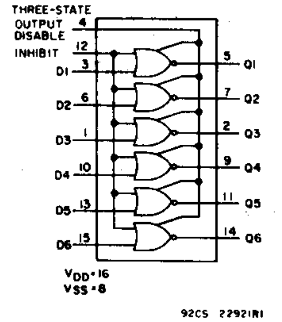
Features:

- 2 TTL-load output drive capability
- 3-state outputs
- Common output-disable control
- Inhibit control
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1 µA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- **Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"**
- **Noise margin (full package-temperature range) =**

1 V at V_{DD} = 5 V
2 V at V_{DD} = 10 V
2.5 V at V_{DD} = 15 V

Applications:

- **3-state hex inverter for interfacing IC's with data buses**
- **COS/MOS to TTL hex buffer**



FUNCTIONAL DIAGRAM

MAXIMUM RATINGS, ***Absolute-Maximum Values:***

DC SUPPLY-VOLTAGE RANGE, (V_{DD})
Voltages referenced to V_{SS} Terminal) .... -0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS .... -0.5V to V_{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT .... ±10mA
POWER DISSIPATION PER PACKAGE (P_D):
For T_A = -55°C to +100°C 500mW
For T_A = +100°C to +125°C .... Derate Linearity at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR
FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) 100mW
OPERATING-TEMPERATURE RANGE (T_A) .... -55°C to +125°C
STORAGE TEMPERATURE RANGE (T_{stg}) .... -65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max .... +265°C

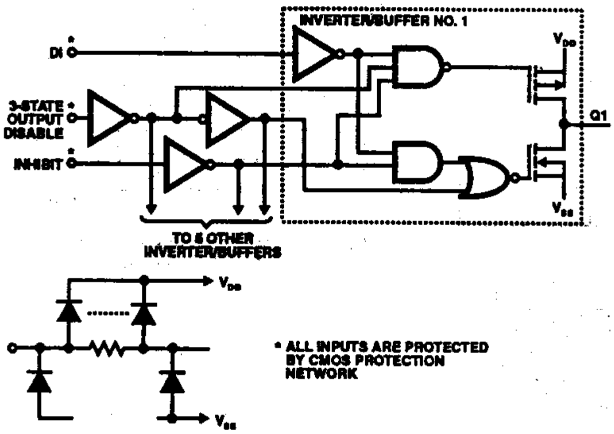
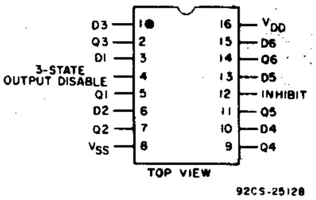


Fig.1 – Logic diagram of 1 of 6 identical inverter/buffers.

TRUTH TABLE

DISABLE	INHIBIT	Dn	Qn
0	0	0	1
0	0	1	0
0	1	X	0
1	X	X	Z

Logic 0 = Low
Z = High Impedance
X = Don't Care
Logic 1 = High



TERMINAL ASSIGNMENT

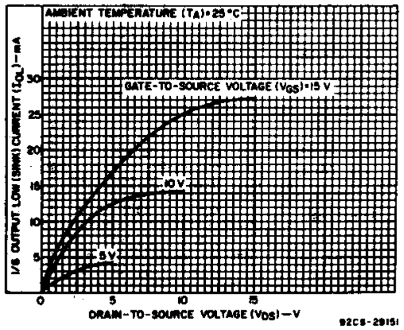


Fig.2 – Typical output low (sink) current characteristics.

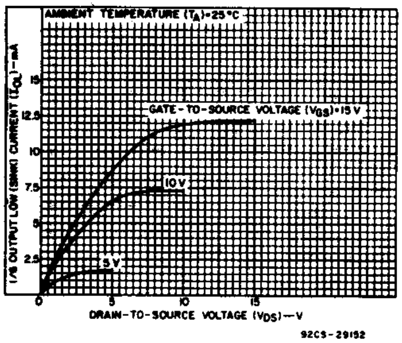


Fig.3 – Minimum output low (sink) current characteristics.

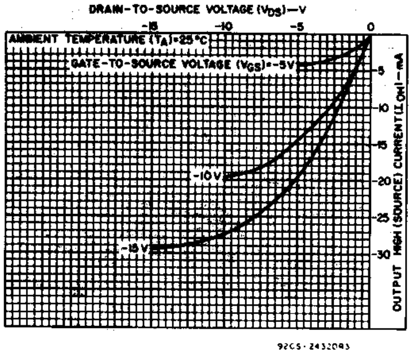


Fig.4 – Typical output high (source) current characteristics.

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	Min.	Max.	
Supply-Voltage Range (For T_A = Full Package-Temperature Range)	3	18	V

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
								+25			
	V_O (V)	V_{IN} (V)	V_{DD} (V)	−55	−40	+85	+125	Min.	Typ.	Max.	
Quiescent Device Current, I_{DD} Max.	–	0,5	5	1	1	30	30	–	0.02	1	µA
	–	0,10	10	2	2	60	60	–	0.02	2	
	–	0,15	15	4	4	120	120	–	0.02	4	
	–	0,20	20	20	20	600	600	–	0.04	20	
Output Low (Sink) Current I_{OL} Min.	0.4	0,5	5	3.84	3.66	2.52	2.16	3.06	6	–	mA
	0.5	0,10	10	9.6	9	6.6	5.4	7.8	15.6	–	
	1.5	0,15	15	25.2	24	16.8	14.4	20.4	40.8	–	
Output High (Source) Current, I_{OH} Min.	4.6	0,5	5	−0.64	−0.61	−0.42	−0.36	−0.51	−1	–	
	2.5	0,5	5	−2	−1.8	−1.3	−1.15	−1.6	−3.2	–	
	9.5	0,10	10	−1.6	−1.5	−1.1	−0.9	−1.3	−2.6	–	
	13.5	0,15	15	−4.2	−4	−2.8	−2.4	−3.4	−6.8	–	
Output Voltage: Low-Level, V_{OL} Max.	–	0,5	5	0.05				–	0	0.05	V
	–	0,10	10	0.05				–	0	0.05	
	–	0,15	15	0.05				–	0	0.05	
Output Voltage: High-Level, V_{OH} Min.	–	0,5	5	4.95				4.95	5	–	
	–	0,10	10	9.95				9.95	10	–	
	–	0,15	15	14.95				14.95	15	–	
Input Low Voltage, V_{IL} Max.	0.5, 4.5	–	5	1.5				–	–	1.5	V
	1, 9	–	10	3				–	–	3	
	1.5, 13.5	–	15	4				–	–	4	
Input High Voltage, V_{IH} Min.	4.5	–	5	3.5				3.5	–	–	
	9	–	10	7				7	–	–	
	13.5	–	15	11				11	–	–	
Input Current I_{IN} Max.		0,18	18	±0.1	±0.1	±1	±1	–	$\pm10^{-5}$	±0.1	µA
3-State Output Leakage Current I_{OUT} Max.	0,18	0,18	18	±0.4	±0.4	±12	±12	–	$\pm10^{-4}$	±0.4	µA

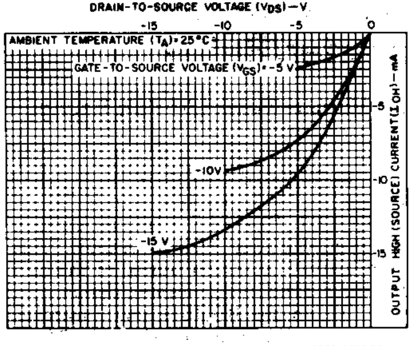


Fig.5 — Minimum output high (source) current characteristics.

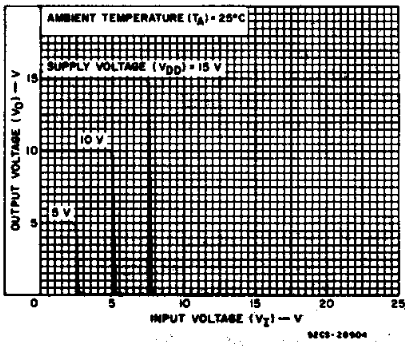


Fig.6 — Typical voltage transfer characteristics.

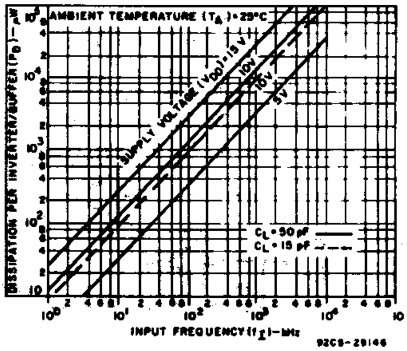


Fig.7 — Typical power dissipation as a function of input frequency.

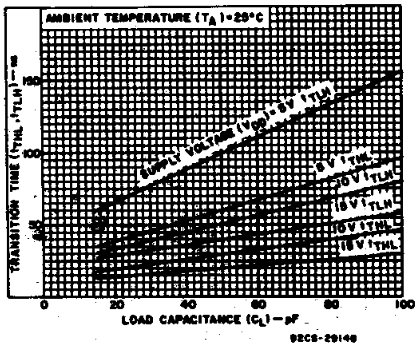


Fig.8 — Typical transition time as a function of load capacitance.

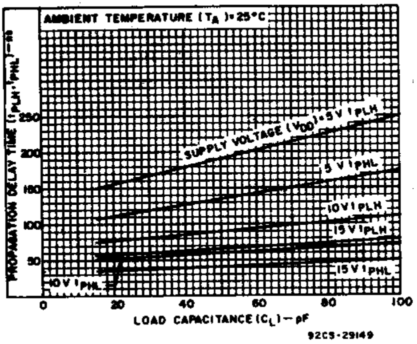


Fig.9 — Typical propagation-delay time as a function of load capacitance.

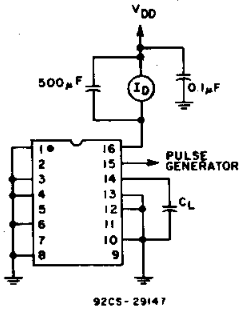


Fig. 10 — Power-dissipation test circuit.

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25°C; Input t_r, t_f = 20 ns, C_L = 50 pF, R_L = 200 KΩ Unless otherwise specified.

CHARACTERISTIC	TEST CONDITIONS		LIMITS		UNITS
		V_{DD} (V)	TYP	MAX	
Data or Inhibit Delay Times: High to Low, t_{PHL}		5 10 15	135 60 40	270 120 80	ns
Low to High, t_{PLH}		5 10 15	190 90 65	380 180 130	
Disable Delay Times: R_L=1 KΩ Output High to High Impedance, t_{PHZ}	See Fig. 14	5 10 15	60 40 30	120 80 60	ns
High-Impedance to Output High, t_{PZH}		5 10 15	110 50 40	220 100 80	
Output Low to High Impedance, t_{PLZ}		5 10 15	125 65 55	250 130 110	
High Impedance to Output Low, t_{PZL}		5 10 15	125 55 40	250 110 80	
Transition Times: Low to High, t_{TLH}		5 10 15	100 50 40	200 100 80	ns
High to Low, t_{THL}		5 10 15	60 30 20	120 60 40	
Input Capacitance, C_{IN}	Any Input		5	7.5	pF
Output Capacitance, C_{OUT}			7-8	15	pF

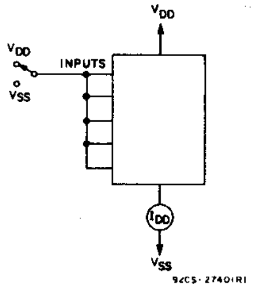


Fig. 11 — Quiescent-device-current test circuit.

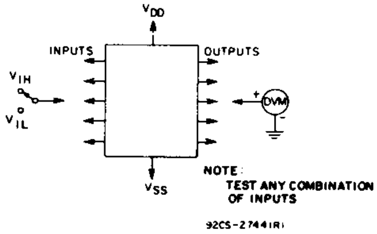


Fig. 12 — Input-voltage test circuit.

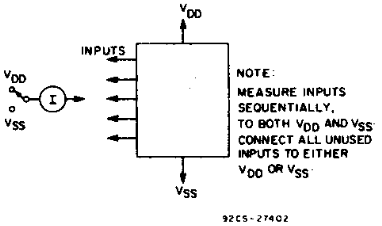
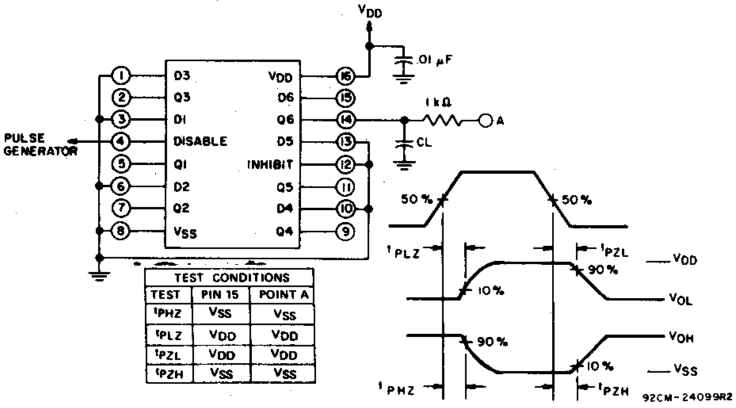
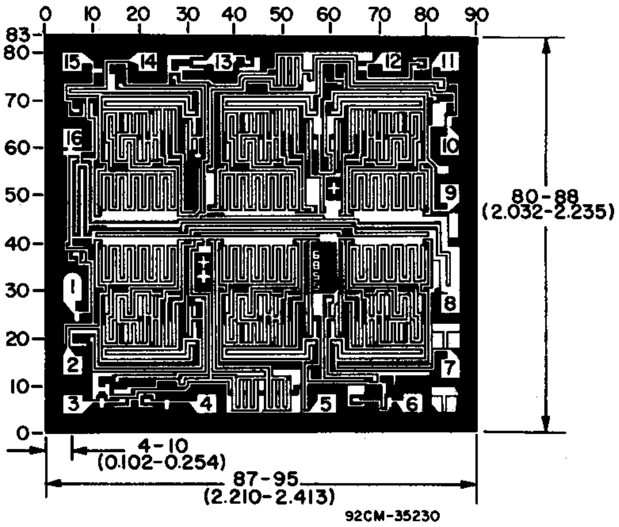


Fig. 13 — Input leakage current test circuit.



TEST CONDITIONS		
TEST	PIN 15	POINT A
t_{PHZ}	V_{SS}	V_{SS}
t_{PLZ}	V_{DD}	V_{DD}
t_{PZL}	V_{DD}	V_{DD}
t_{PZH}	V_{SS}	V_{SS}

Fig. 14 — Disable delay times test circuit and waveforms.



Dimensions and Pad Layout for CD4502BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch.)

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